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TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}\left(\Omega\right)$

Q_{gs} (nC)

Q_{gd} (nC)

Q_q max. (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

2.2

600

23

5.4

11

Single

 $V_{GS} = 10 V$

FEATURES

· Low gate charge Qg results in simple drive requirement



- Improved gate, avalanche, and dynamic dV/dt ruggedness
- Fully characterized capacitance and avalanche voltage and current
- Effective Coss specified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

APPLICATIONS

- Switch mode power supply (SMPS)
- Uninterruptable power supply
- High speed power switching

TYPICAL SMPS TOPOLOGY

Single Transistor flyback

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRFBC30APbF			
Lead (Pb)-free and halogen-free	IRFBC30APbF-BE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600		
Gate-source voltage			V _{GS}	± 30	- V	
	N	T _C = 25 °C		3.6		
Continuous drain current	V _{GS} at 10 V	T _C = 100 °C	I _D	2.3	А	
Pulsed drain current ^a	I _{DM}	14				
Linear derating factor				0.69	W/°C	
Single pulse avalanche energy ^b			E _{AS}	290	mJ	
Repetitive avalanche current ^a			I _{AR}	3.6	A	
Repetitive avalanche energy ^a			E _{AR}	7.4	mJ	
Maximum power dissipation T _C = 25 °C			PD	74	W	
Peak diode recovery dV/dt ^c			dV/dt	7.0	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150		
Soldering recommendations (peak temperature) ^d	For	10 s		300	- °C	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting torque				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11) b. Starting T_J = 25 °C, L = 41 mH, R_g = 25 Ω , I_{AS} = 3.6 A (see fig. 12) c. I_{SD} \leq 3.6 A, dI/dt \leq 170 A/µs, V_{DD} \leq V_{DS}, T_J \leq 150 °C

d. 1.6 mm from case

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THERMAL RESISTANCE RAT	TINGS							
PARAMETER	SYMBOL	TYP. MAX.		UNIT				
Maximum junction-to-ambient	R _{thJA}	- 62						
Case-to-sink, flat, greased surface	R _{thCS}	0.50	0.50 -		°C/W			
Maximum junction-to-case (drain)	R _{thJC}	-		1.7				
SPECIFICATIONS (T _J = 25 °C, PARAMETER	, unless otherwi	1	CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$		600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, $I_D = 1 \text{ mA}$		-	0.67	-	V/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2.0	-	4.5	V	
Gate-source leakage	I _{GSS}	$V_{GS} = \pm 30 \text{ V}$		-	-	± 100	nA	
7	1	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	25		
Zero gate voltage drain current	e gate voltage drain current I_{DSS} $V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	250	μA		
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D	= 2.2 A ^b	-	-	2.2	Ω
Forward transconductance	9 _{fs}	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 2.2 \text{ A}^{\text{b}}$		2.1	-	-	S	
Dynamic						•	•	
Input capacitance	C _{iss}	$V_{GS} = 0 V,$		-	510	-		
		- · · · · · · · · · · · · · · · · · · ·					1	

Input capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V,		-	510	-	
Output capacitance	C _{oss}			-	70	-	
Reverse transfer capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	3.5	-	
	C _{oss}		V _{DS} = 1.0 V, f = 1.0 MHz	-	730	-	pF
Output capacitance		$V_{GS} = 0 V$	V _{GS} = 0 V V _{DS} = 480 V, f = 1.0 MHz		19	-	
Effective output capacitance	C _{oss} eff.		V_{DS} = 0 V to 480 V ^c	-	31	-	
Total gate charge	Qg			-	-	23	nC
Gate-source charge	Q _{gs}	V _{GS} = 10 V	I _D = 3.6 A, V _{DS} = 480 V see fig. 6 and 13 ^b	-	-	5.4	
Gate-drain charge	Q _{gd}		see fig. 6 and 13 b		-	11	
Turn-on delay time	t _{d(on)}	$V_{DD} = 300 \text{ V}, \text{ I}_D = 3.6 \text{ A},$ $R_g = 12 \Omega, R_D = 82 \Omega, \text{ see fig. 10 }^{\text{b}}$ f = 1 MHz, open drain		-	9.8	-	ns
Rise time	t _r			-	13	-	
Turn-off delay time	t _{d(off)}			-	19	-	
Fall time	t _f			-	12	-	
Gate input resistance	R _g			0.8	-	4.6	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the		-	-	3.6	А
Pulsed diode forward current ^a	I _{SM}	p - n junction diode		-	-	14	A
Body diode voltage	V _{SD}	T_{J} = 25 °C, I_{S} = 3.6 A, V_{GS} = 0 V ^b		-	-	1.6	V
Body diode reverse recovery time	t _{rr}	$T_{\rm J} = 25 ^{\circ}\text{C}, I_{\rm F} = 3.6 \text{A}, dl/dt = 100 \text{A}/\mu\text{s}^{\rm b}$		-	400	600	ns
Body diode reverse recovery charge	Q _{rr}			-	1.1	1.7	μC
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)					

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

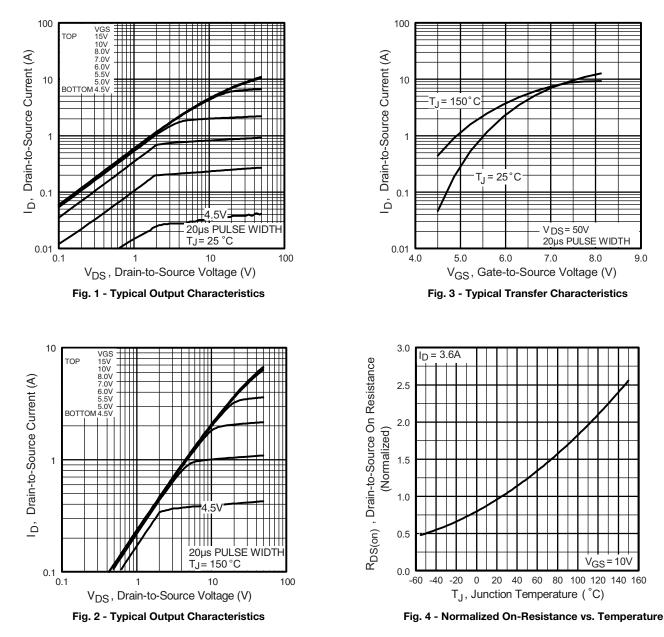
c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



3



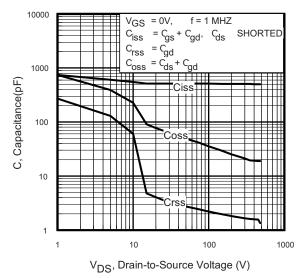


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

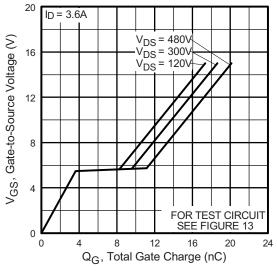


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

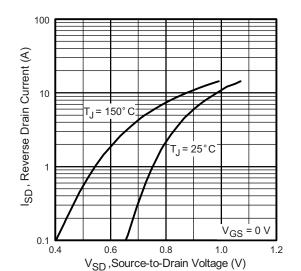


Fig. 7 - Typical Source-Drain Diode Forward Voltage

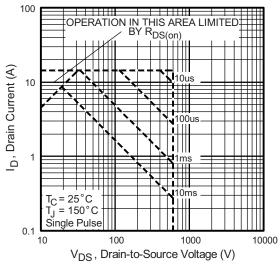


Fig. 8 - Maximum Safe Operating Area



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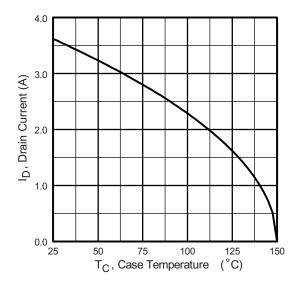


Fig. 9 - Maximum Drain Current vs. Case Temperature

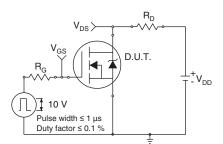


Fig. 10a - Switching Time Test Circuit

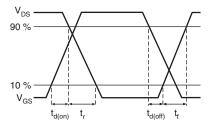
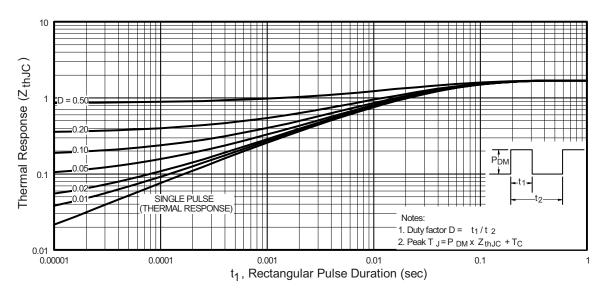


Fig. 10b - Switching Time Waveforms





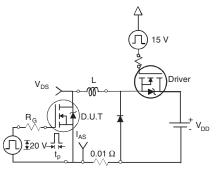
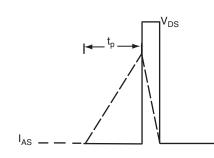
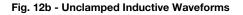


Fig. 12a - Unclamped Inductive Test Circuit





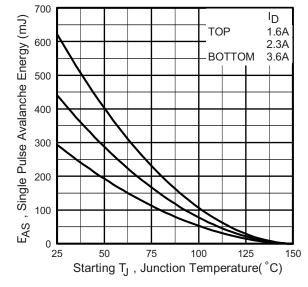
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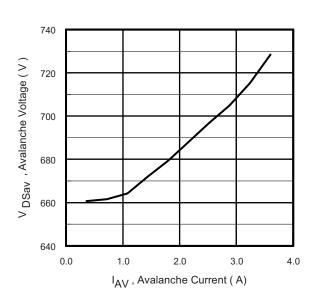
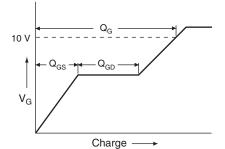
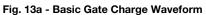
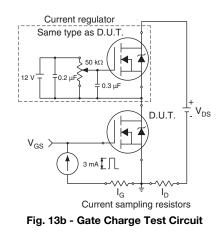
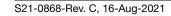


Fig. 12d - Typical Drain-to-Source Voltage vs. Avalanche Current





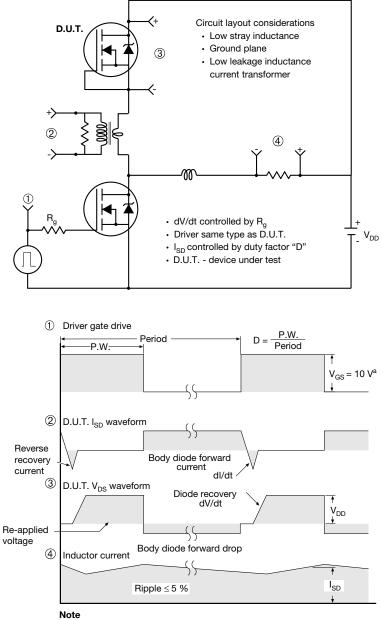




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Peak Diode Recovery dV/dt Test Circuit



a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture						
AS	3E	Xi'an				
		IRF 9510 744K AB				

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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